TW/Chemtronics® /Americas















Soder-Wick® No Clean SD

The world's leading brand of desoldering braid

- Soder-Wick® No Clean packaged in ESD-safe static dissipative bobbins
- · Minimizes the risk of damage associated with static electricity
- Patented noncorrosive, halide free, organic no-clean flux
- Desolders up to 40% faster than competitive no-clean braids and leaves boards cleaner
- Meets Bellcore TR-NWT-000078 and ANSI IPC SF-818 for Surface Insulation Resistance
- Meets parameters tested by the Singapore Institute of Standards and Industrial Research (SISIR) for Solderability
- ANSI/IPC J STD-004, Type ROL0

Product Selection Guide

PRODUCT	SIZE		COLOR	5' 1.5m	10' 3.0m	25' 7.5m	100¹ 30.5m	500' 152.5m	VACUPAK™	APPLICATION
Soder-Wick® No Clean SD	1	.030"/0.8mm	White	60-1-5	60-1-10				SW16015	SMD, Micro-Circuits
	2	.060"/1.5mm	Yellow	60-2-5	60-2-10				SW16025	Small Pads, SMDs
	3	.080"/2.0mm	Green	60-3-5	60-3-10				SW16035	Medium Pads
	4	.110"/2.8mm	Blue	60-4-5	60-4-10				SW16045	Large Pads
	5	.145"/3.7mm	Brown	60-5-5	60-5-10				SW16055	Terminals
	6	.210"/5.3mm	Red	60-6-5						Large Lugs

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